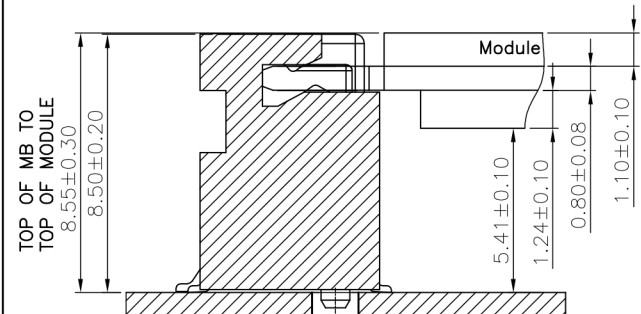
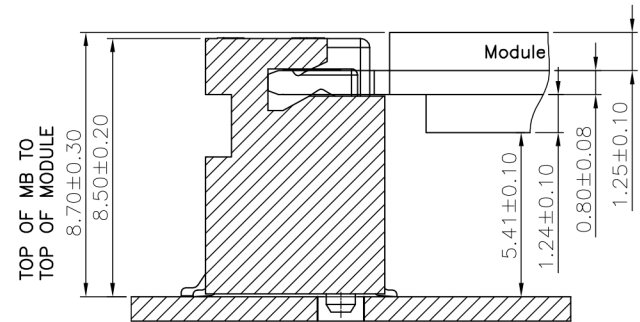


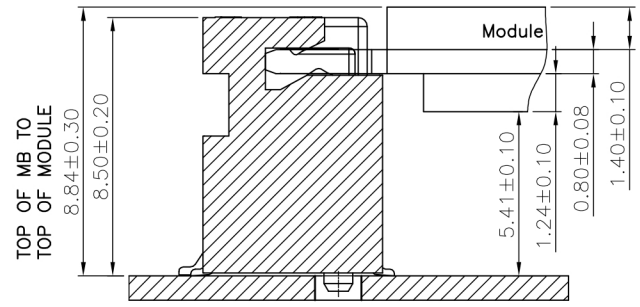
Assembly stack height schematic diagram



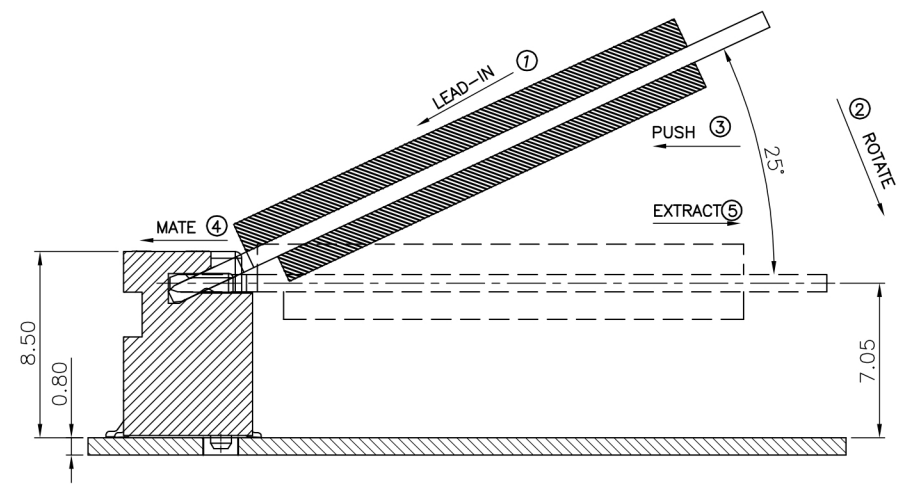
Stack-up Top Mount Double Sided Module
for 1.20 max top-side component height



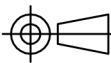
Stack-up Top Mount Double Sided Module
for 1.35 max top-side component height

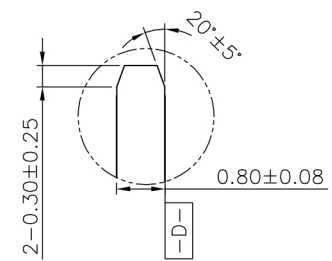
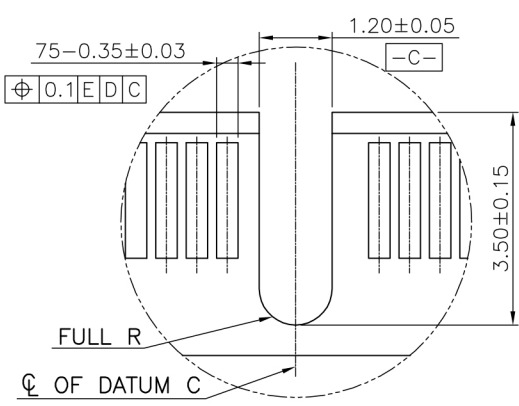
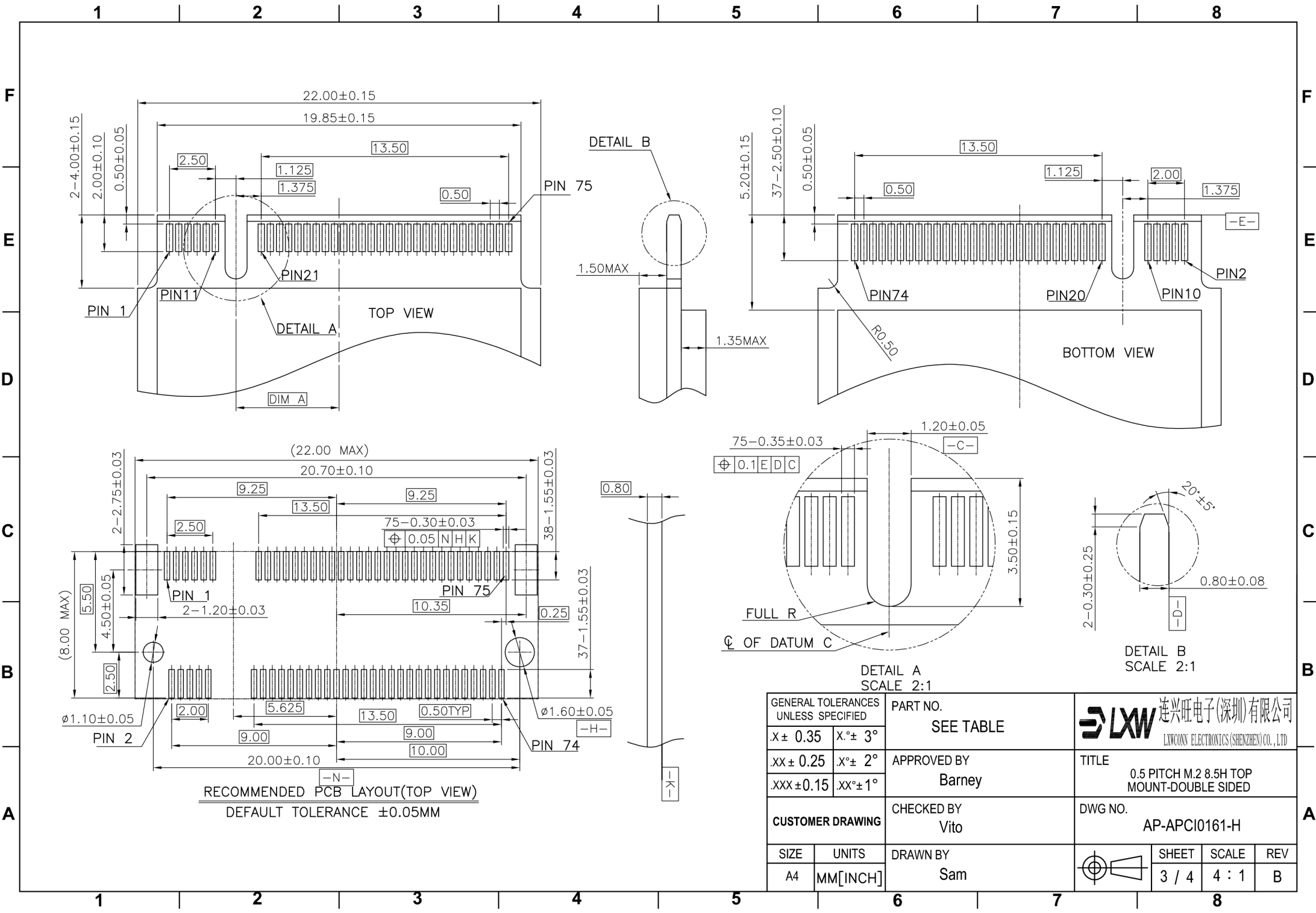


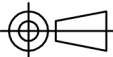
Stack-up Top Mount Double Sided Module
for 1.35 max top-side component height

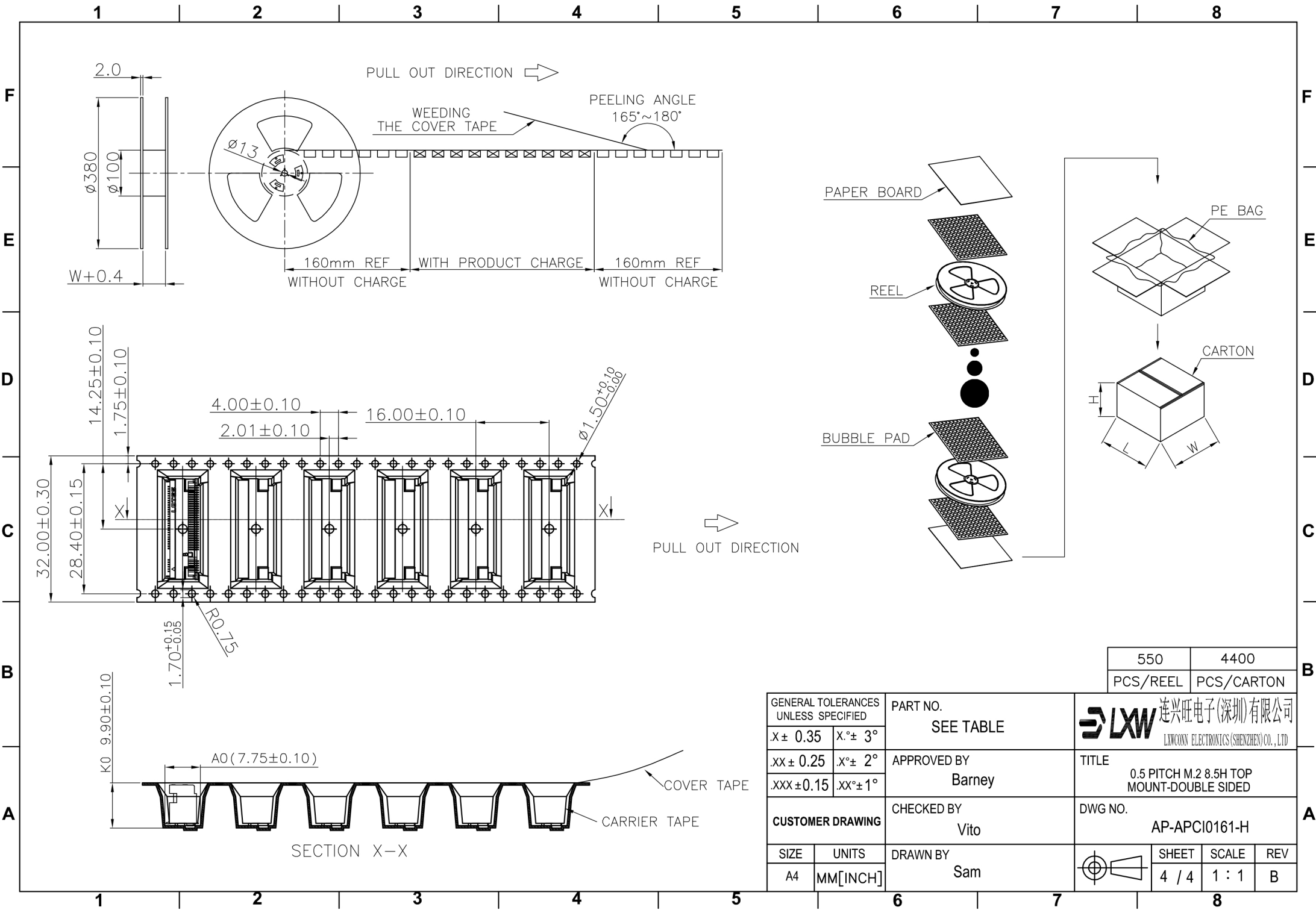


HOW TO MATE AND EXTRACT
MATE: ① → ④
EXTRACT: ⑤
NOTE: Mating force will generate
from step 3 to step 4.

GENERAL TOLERANCES UNLESS SPECIFIED		PART NO. SEE TABLE	 连兴旺电子(深圳)有限公司 LIXWONN ELECTRONICS (SHENZHEN) CO., LTD			
.X ± 0.35	X° ± 3°	APPROVED BY Barney	TITLE 0.5 PITCH M.2 8.5H TOP MOUNT-DOUBLE SIDED			
.XX ± 0.25	X° ± 2°		DWG NO. AP-APCI0161-H			
.XXX ± 0.15	.XX° ± 1°					
CUSTOMER DRAWING		CHECKED BY Vito				
SIZE A4	UNITS MM[INCH]	DRAWN BY Sam		SHEET 2 / 4	SCALE 4 : 1	REV B

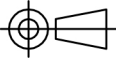


GENERAL TOLERANCES UNLESS SPECIFIED		PART NO. SEE TABLE	 连兴旺电子(深圳)有限公司 LXWCONN ELECTRONICS (SHENZHEN) CO., LTD				
X± 0.35	X.°± 3°		APPROVED BY Barney	TITLE 0.5 PITCH M.2 8.5H TOP MOUNT-DOUBLE SIDED			
.XX± 0.25	X°± 2°						
.XXX±0.15	.XX°± 1°						
CUSTOMER DRAWING		CHECKED BY Vito	DWG NO. AP-APCI0161-H				
SIZE	UNITS	DRAWN BY Sam					
A4	MM[INCH]		SHEET 3 / 4	SCALE 4 : 1	REV B		



GENERAL TOLERANCES UNLESS SPECIFIED	
.X $\pm$ 0.35	X. $^\circ$ $\pm$ 3 $^\circ$
.XX $\pm$ 0.25	X. $^\circ$ $\pm$ 2 $^\circ$
.XXX $\pm$ 0.15	.XX. $^\circ$ $\pm$ 1 $^\circ$
CUSTOMER DRAWING	
SIZE	UNITS
A4	MM[INCH]

PART NO. SEE TABLE	
APPROVED BY Barney	
CHECKED BY Vito	
DRAWN BY Sam	

550		4400	
PCS/REEL		PCS/CARTON	
 连兴旺电子(深圳)有限公司 LXWONN ELECTRONICS(SHENZHEN)CO., LTD			
TITLE 0.5 PITCH M.2 8.5H TOP MOUNT-DOUBLE SIDED			
DWG NO. AP-APCI0161-H			
	SHEET	SCALE	REV
	4 / 4	1 : 1	B